

For Reference Only – Not for Tooling Use

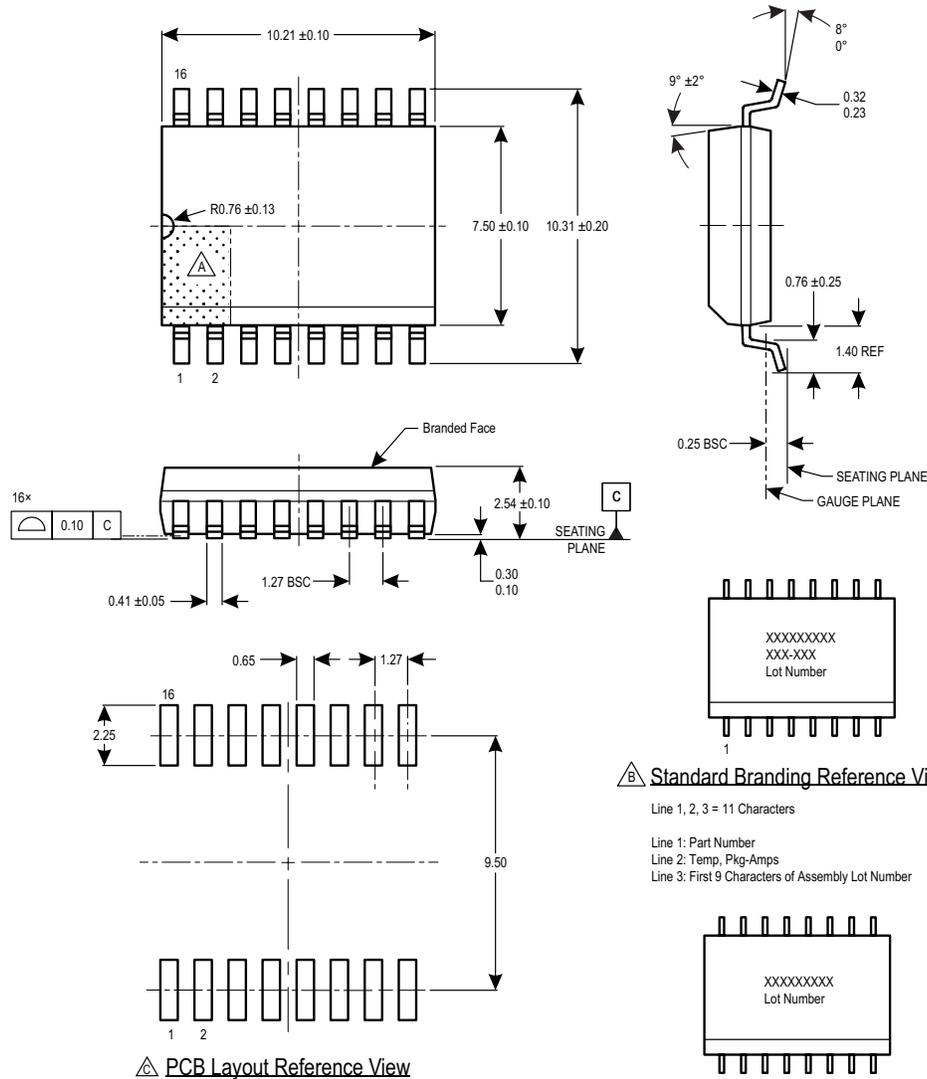
(Reference Allegro DWG-0000388, Rev. 1 and JEDEC MS-013AA)

NOT TO SCALE

Dimensions in millimeters

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown



-  Terminal #1 mark area
-  Branding scale and appearance at supplier discretion
-  Reference land pattern layout (reference IPC7351 SOIC127P600X175-8M); all pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances

Standard Branding Reference View

Line 1, 2, 3 = 11 Characters

Line 1: Part Number
Line 2: Temp, Pkg-Amps
Line 3: First 9 Characters of Assembly Lot Number

Standard Branding Reference View

For new devices released after 2/1/2016, Device transfers may use original branding format.

Line 1, 2 = 11 Characters

Line 1: Part Number
Line 3: First 9 Characters of Assembly Lot Number

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